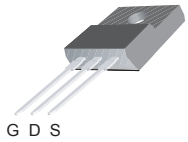
STP45L01F

N-Channel Enhancement Mode Field Effect Transistor

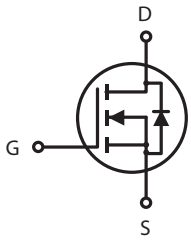
PRODUCT SUMMARY		
V_{DSS}	I_D	$R_{DS(ON)}$ (mΩ) Typ
100V	40A	20 @ VGS=10V

FEATURES

- Super high dense cell design for low $R_{DS(ON)}$.
- Rugged and reliable.
- TO-220F Package.



STF SERIES
TO-220F



ABSOLUTE MAXIMUM RATINGS (T_C=25°C unless otherwise noted)

Symbol	Parameter		Limit	Units
V_{DS}	Drain-Source Voltage		100	V
V_{GS}	Gate-Source Voltage		±20	V
I_D	Drain Current-Continuous [a]	T_C=25°C	40	A
		T_C=70°C	32	A
I_{DM}	-Pulsed [b]		118	A
E_{AS}	Avalanche Energy [d]		560	mJ
P_D	Maximum Power Dissipation [a]	T_C=25°C	62.5	W
		T_C=70°C	40	W
T_J, T_{STG}	Operating Junction and Storage Temperature Range		-55 to 150	°C

THERMAL CHARACTERISTICS

$R_{\theta JC}$	Thermal Resistance, Junction-to-Case [a]	2	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient [a]	50	°C/W

ELECTRICAL CHARACTERISTICS (T_A=25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
OFF CHARACTERISTICS						
BV_{DSS}	Drain-Source Breakdown Voltage	V_{GS}=0V , I_D=250uA	100			V
I_{DSS}	Zero Gate Voltage Drain Current	V_{DS}=80V , V_{GS}=0V			1	uA
I_{GSS}	Gate-Body Leakage Current	V_{GS}= ±20V , V_{DS}=0V			±100	nA
ON CHARACTERISTICS						
$V_{GS(th)}$	Gate Threshold Voltage	V_{DS}=V_{GS} , I_D=250uA	2	2.9	4	V
$R_{DS(ON)}$	Drain-Source On-State Resistance	V_{GS}=10V , I_D=20A		20	25	m ohm
g_{FS}	Forward Transconductance	V_{DS}=10V , I_D=20A		24		S
DYNAMIC CHARACTERISTICS [c]						
C_{ISS}	Input Capacitance	V_{DS}=25V,V_{GS}=0V f=1.0MHz		3200		pF
C_{OSS}	Output Capacitance			241		pF
C_{RSS}	Reverse Transfer Capacitance			176		pF
SWITCHING CHARACTERISTICS [c]						
$t_{D(ON)}$	Turn-On Delay Time	V_{DD}=50V I_D=1A V_{GS}=10V R_{GEN}= 6 ohm		81		ns
tr	Rise Time			74		ns
$t_{D(OFF)}$	Turn-Off Delay Time			67		ns
tf	Fall Time			39		ns
Q_g	Total Gate Charge	V_{DS}=50V,I_D=20A,V_{GS}=10V		40		nC
Q_{gs}	Gate-Source Charge	V_{DS}=50V,I_D=20A, V_{GS}=10V		8		nC
Q_{gd}	Gate-Drain Charge			10.2		nC
DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS						
V_{SD}	Diode Forward Voltage	V_{GS}=0V,I_S=7A		0.78	1.3	V

Notes

a.Surface Mounted on FR4 Board,t ≤ 10sec.
b.Pulse Test:Pulse Width ≤ 300us, Duty Cycle ≤ 2%.
c.Guaranteed by design, not subject to production testing.
d.Starting T_J=25°C,L=5mH,V_{DD} = 80V.(See Figure13)

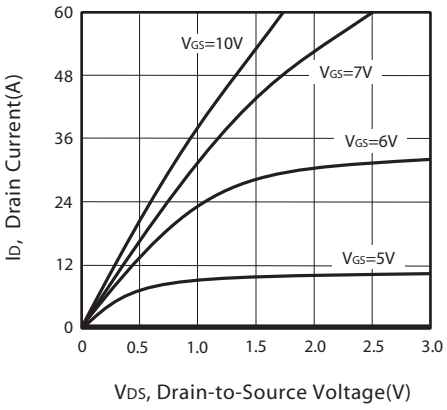


Figure 1. Output Characteristics

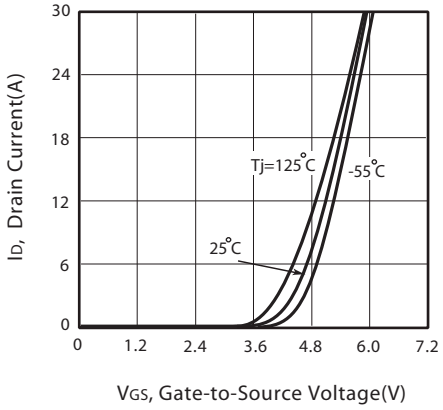


Figure 2. Transfer Characteristics

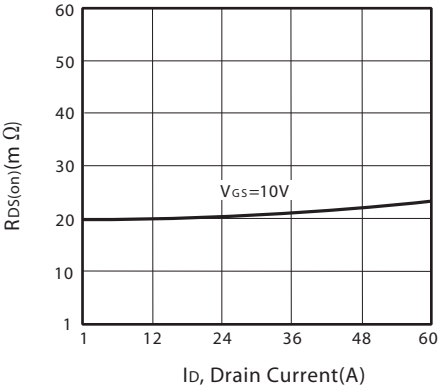


Figure 3. On-Resistance vs. Drain Current and Gate Voltage

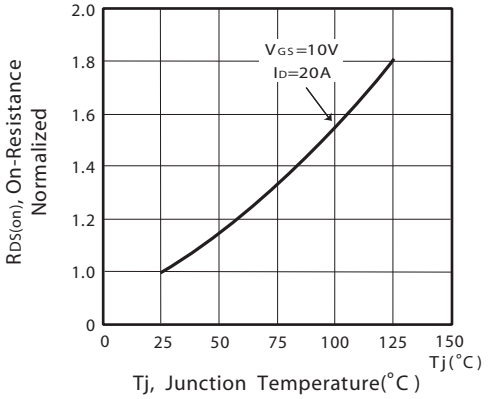


Figure 4. On-Resistance Variation with Drain Current and Temperature

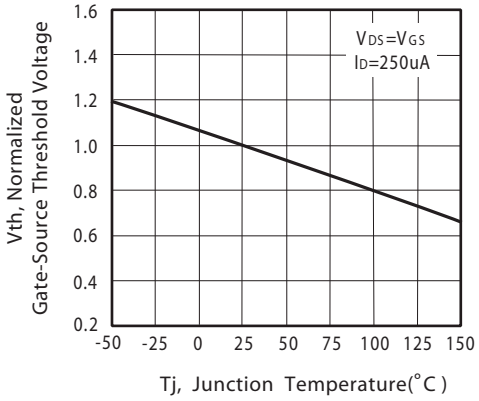


Figure 5. Gate Threshold Variation with Temperature

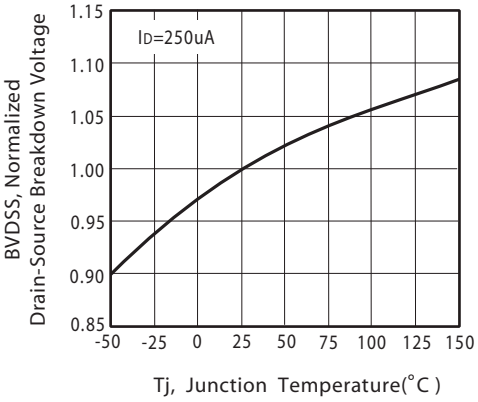


Figure 6. Breakdown Voltage Variation with Temperature

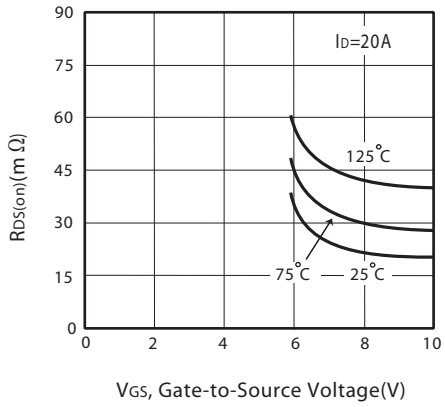


Figure 7. On-Resistance vs. Gate-Source Voltage

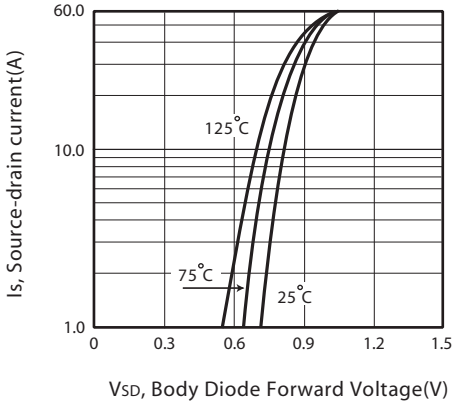


Figure 8. Body Diode Forward Voltage Variation with Source Current

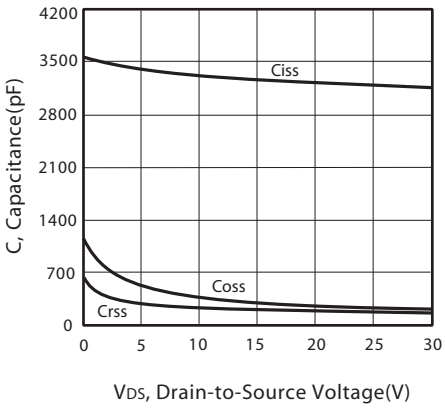


Figure 9. Capacitance

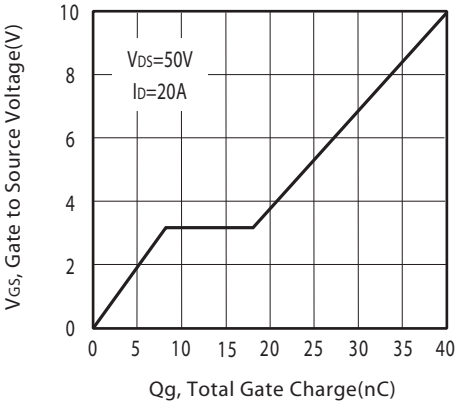


Figure 10. Gate Charge

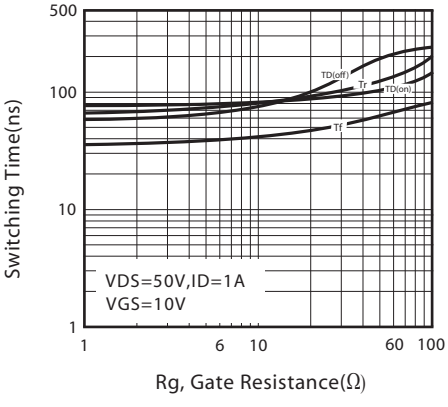


Figure 11. switching characteristics

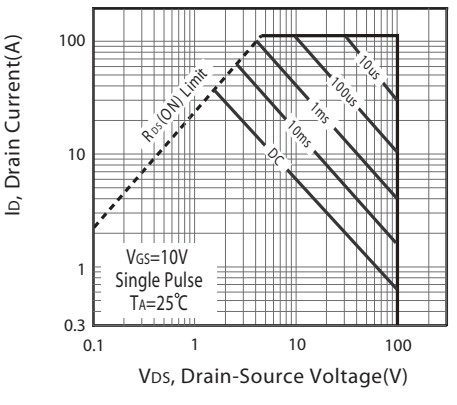
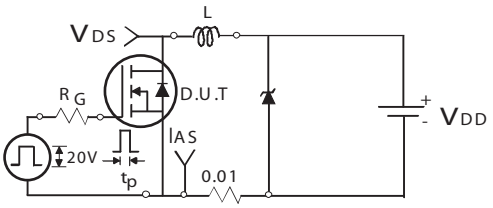
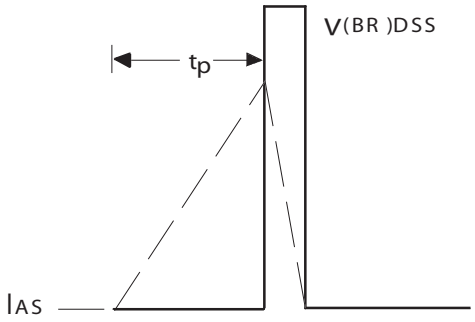


Figure 12. Maximum Safe Operating Area



Unclamped Inductive Test Circuit

Figure 13a.



Unclamped Inductive Waveforms

Figure 13b.

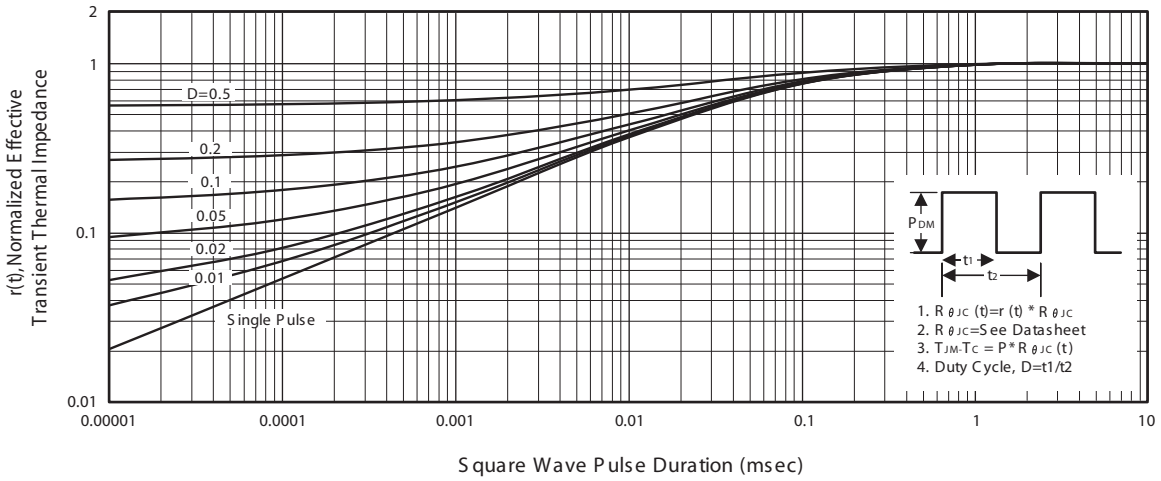
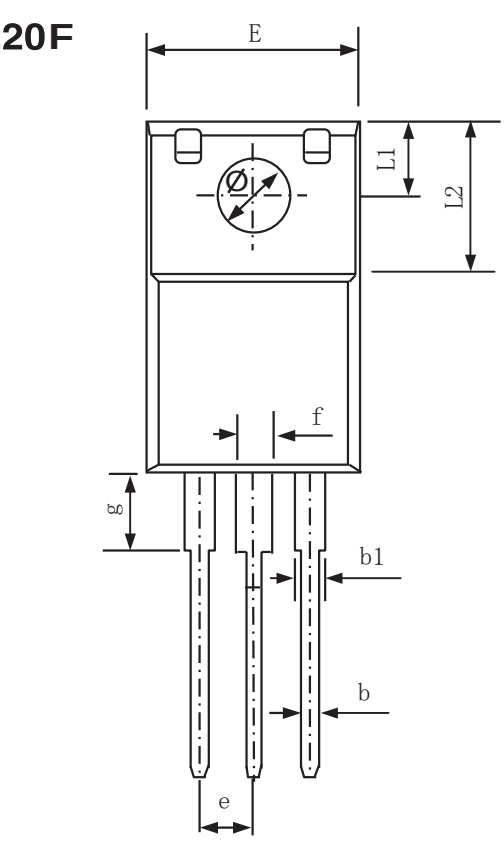
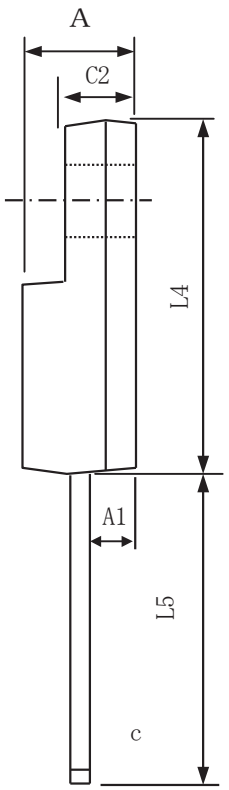


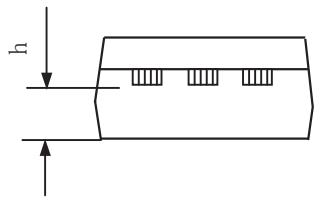
Figure 14. Normalized Thermal Transient Impedance Curve

PACKAGE OUTLINE DIMENSIONS

TO-220F

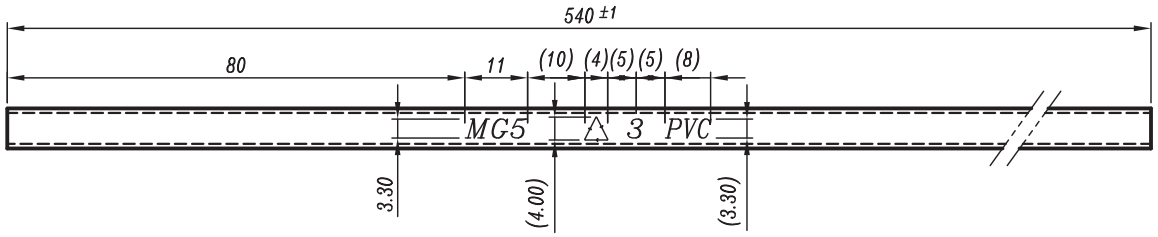




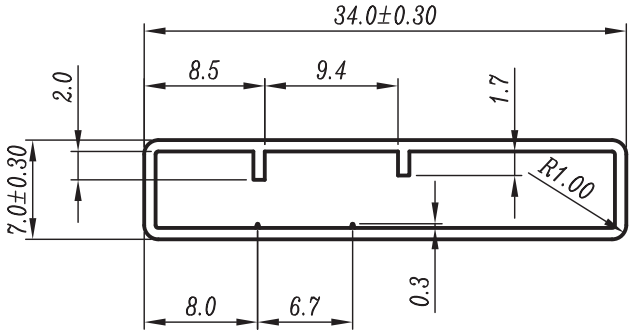


SYMBOLS	MILLIMETERS	
	MIN	MAX
A	4.20	4.80
A1	1.95	2.85
b	0.56	1.05
b1	0.90	1.50
c	0.55	0.80
c2	2.50	3.10
E	9.70	10.30
L1	3.20	3.80
L2	6.90	7.50
L4	15.60	16.40
L5	13.50	14.50
Ø	3.20	
e	2.55	
f	1.30	1.90
g	3.40	3.80
h	2.10	2.70

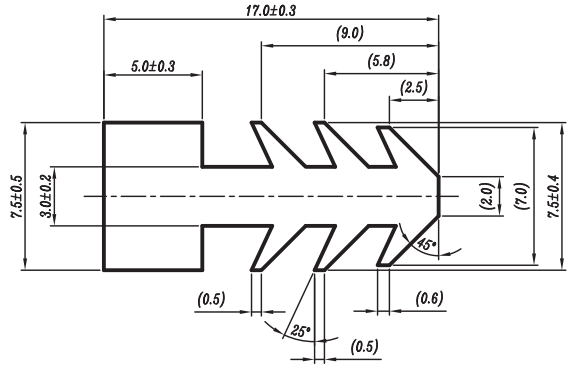
TO-220F Tube



t=0.8 ±0.15



SCALE=2/1



L=8.0 $^{+0.5}_{-1}$